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PCN Date: 23Mar11		Effective Date: 23Mar11	
Title: Si403x/433x/443x/4313 EZRadioPRO Improved MSL1 Performance			
Originator: Hardy Schmidbauer		Phone: 408.702.1277	Dept: Marketing
Customer Contact: Kathy Hagggar		Phone: 512.532.5261	Dept: Sales
PCN Type: <input type="checkbox"/> Assembly <input type="checkbox"/> Discontinuance <input checked="" type="checkbox"/> Package <input type="checkbox"/> Test <input type="checkbox"/> Datasheet <input type="checkbox"/> Fabrication <input type="checkbox"/> Product Revision <input type="checkbox"/> Packing <input type="checkbox"/> Labeling <input type="checkbox"/> Location <input type="checkbox"/> Other			
Last Order Date: N/A			
PCN Details			
Description of Change: Silicon Laboratories, Inc. (Silicon Labs) is pleased to announce improved Moisture Sensitivity Level (MSL) from MSL2 to MSL1 for all EZRadioPRO products.			
Reason for Change: Improve part manufacturing exposure time.			
Impact on Form, Fit, Function, Quality, Reliability: There is no impact on form, fit, function, quality or reliability. No Change was made to the existing BOM. No Changes were required for PCB layout or manufacture.			









Product Identification:

This PCN applies to devices ordered using the following ordering part numbers:









Affected Ordering Part Numbers	
Si4030-A0-FM	Si4330-B1-ZM1
Si4030-B1-FM	Si4330-B1-ZM2
Si4031-A0-FM	Si4430-A0-FM
Si4031-B1-FM	Si4430-B1-FM
Si4031-B1-ZM1	Si4431-A0-FM
Si4031-B1-ZM2	Si4431-B1-FM
Si4032-B1-FM	Si4431-B1-ZM1
Si4032-B1-ZM1	Si4431-B1-ZM2
Si4032-B1-ZM2	Si4432-B1-FM
Si4032-V2-FM	Si4432-B1-ZM1
Si4313-B1-FM	Si4432-B1-ZM2
Si4330-A0-FM	Si4432-V2-FM
Si4330-B1-FM	

Note: Affected Part Numbers also include tape and reel equivalents ("R" suffix).

Current Inner Box Label

(K) TRANS ID: 	MSLP. Reflow (C)E Tim 1 260 UNL
(P) CUSTOMER PROD ID: 	
(1P) SUPPLIER PROD ID: SI4030-A0-FM 	
(D) DATECODE1: 	(Q) QTY1: 
(D) DATECODE2: 	(Q) QTY2: 
1000365427 	Pb-Free (E3) SEAL DATE: 07-Jan-11

Old Inner Box Label

(K) TRANS ID: 	MSLP. Reflow (C)E Tim 2 260 UNL
(P) CUSTOMER PROD ID: 	
(1P) SUPPLIER PROD ID: SI4030-A0-FM 	
(D) DATECODE1: 	(Q) QTY1 
(D) DATECODE2: 	(Q) QTY2: 
1000365427 	Pb-Free (E3) SEAL DATE: 07-Jan-11

Last Date of Unchanged Product: 23Mar11

Following the Effective Date of this PCN, the Silicon Labs product shipping label will reflect the improved MSL1 level.

Qualification Samples: N/A

Qualification Data: See Appendix A for the Qualification Report

Appendix A: Qualification Report

Si443X-B1-FM Qualification Report



W7206F1 Product Qualification Plan and Report Rev. D

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Part Rev B1, JAZZ SEMI Fabrication, UNISEM Assembly except as noted							
Test Name	Test Condition	Qualification	Lot ID or Start	Fail/Pass or End	Notes	Summary	Status
Test Group A - Accelerated Environment Stress Tests							
Moisture Reflow/Sensitivity	JA113	3 lots, N=>22	Q26277	0/22	1		
	Reflow 3X 260°C		Q26251	0/22	1		
	22pc CSAM per Qual		Q25796	0/22	1	4 lots	
			Q25831	0/22	1	0/88	Pass
HAST	JA110	3 lots, N=>77	Q28166	0/79			
	130°C, 85%RH		Q28167	0/80	2	3 lots	
	Vcc=3.6V, 96 hours		Q28168	0/79		0/238	Pass
Temp Cycle	JA104	3 lots, N=>77	Q28169	0/80			
	Cond C: -65°C to 150°C		Q28170	0/80	2	3 lots	
	500 cycles		Q28171	0/80		0/240	Pass
HTSL	JA103		Q28172	0/45		1 lot	
	150°C, 1000hr	1 lot, N=>45				0/45	Pass
Test Group B - Accelerated Lifetime Simulation Tests							
HTOL	JA108	3 lots, N=>77	Q28163	0/85			
	125°C, Dynamic		Q28164	0/85	2	3 lots	
	Vcc=3.6V, 1000 hours		Q28165	0/85		0/255	Pass
LTOL	JA108	1 lot, N=>77	Q27156	0/80	3		
	-10°C, Dynamic					1 lot	
	Vcc=3.6V, 1000 hours					0/80	Pass
ELFR	AEC-Q100-008	3 lots, N=>800	Q28118	0/807	2		
	125°C, Dynamic		Q28119	0/802			
	Vcc=3.6V, 48 hours		Q28120	0/809		4 lots	
			Q28523	0/818		0/3236	Pass
Test Group C - Package Assembly Integrity Tests							
Wire Bond Shear	AEC-Q100-001	5 units, N=>30	392729	0/30			
			393487	0/30		3 lots	
			394703	0/30		0/0	Pass
Wire Bond Pull	M-STD-883	5 units, N=>30	392729	0/30			
	Performed post-TC		393487	0/30		3 lots	
			394703	0/30		0/0	Pass
Physical Dimensions	JB100	3 lots, N=>10	392729	0/10			
			393487	0/10		3 lots	
			394703	0/10		0/30	Pass
Solderability	JB102	1 lot, N=>15	392729	0/15			
			393487	0/15		3 lots	
			394703	0/15		0/45	Pass
Test Group E - Electrical Verification							

Appendix A: Qualification Report (cont)

Si443X-B1-FM Qualification Report



W7101F1 Product Qualification Plan and Report Rev. D

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Part Rev B1, JAZZ SEMI Fabrication, UNISEM Assembly except as noted							
Test Name	Test Condition	Qualification	Lot ID or Start	Fail/Pass or End	Notes	Summary	Status
ESD-HBM	AEC-Q100-002	1 lot, N=>3	Q28124	0/3	4	±1000V	Pass
			Q28131	0/3		±2000V	
ESD-MM	AEC-Q100-003	1 lot, N=>3	Q28394	0/3	5	±45V	Pass
			Q28132	0/3		±150V	
ESD-CDM	AEC-Q100-011	1 lot, N=>3	Q28126	0/3		±500V	Pass
Latch Up	AEC-Q100-004	1 lot, N=>6	Q28122	0/6		25°C	Pass
			Q28123	0/6		85°C	
Gate Leakage	AEC-Q100-006	1 lot, N=>6	Q28121	0/6		1 lot 0/6	Pass
Electromagnetic Compatibility	SAE J1752	1 lot, N=>1	Q28597	0/1		1 lot 0/1	Pass

Notes:

1. Devices subjected to moisture preconditioning at MSL1@260°C
2. Qualification performed with revision A0 silicon
3. Qualification performed with revision V2 silicon
4. ESD-HBM passed 2KV excluding RF pins. All pins passed 1KV
5. ESD-MM passed 150V excluding RF pins. All pins passed 45V